

# Schmitt-trigger Inverter Buffer

REJ03D0111-0300Z (Previous ADE-205-627B (Z)) Rev.3.00 Nov.12.2003

## **Description**

The HD74ALVC1G14 has an inverter with schmitt-trigger input in a 5 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

#### **Features**

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Supply voltage range : 1.2 to 3.6 V
   Operating temperature range : -40 to +85°C
- All inputs  $V_{IH}$  (Max.) = 3.6 V (@ $V_{CC}$  = 0 V to 3.6 V)

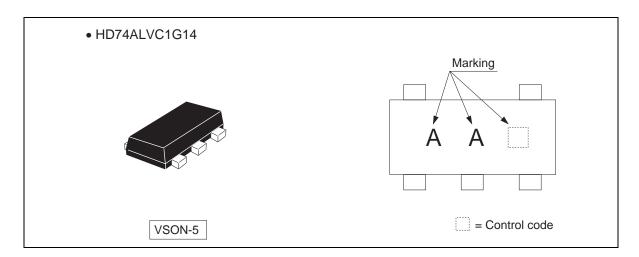
All outputs 
$$V_0$$
 (Max.) = 3.6 V (@ $V_{CC}$  = 0 V)

- Output current  $\pm 2$  mA (@V<sub>CC</sub> = 1.2)  $\pm 4$  mA (@V<sub>CC</sub> = 1.4 V to 1.6 V)  $\pm 6$  mA (@V<sub>CC</sub> = 1.65 V to 1.95 V)  $\pm 18$  mA (@V<sub>CC</sub> = 2.3 V to 2.7 V)  $\pm 24$  mA (@V<sub>CC</sub> = 3.0 V to 3.6 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

			Package	l aping Abbreviation
Part Name	Package Type	Package Code	Abbreviation	(Quantity)
HD74ALVC1G14VSE	VSON-5 pin	TNP-5DV	VS	E (3,000 pcs/reel)



#### **Outline and Article Indication**

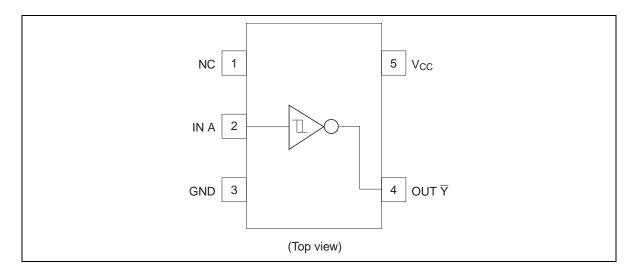


## **Function Table**

Input A	Output \( \overline{Y} \)
Н	L
L	Н

H: High level L: Low level

### **Pin Arrangement**



## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V <sub>CC</sub>	-0.5 to 4.6	V	
Input voltage range *1	Vı	-0.5 to 4.6	V	
Output voltage range *1, 2	Vo	-0.5 to V <sub>CC</sub> +0.5	V	Output : H or L
		-0.5 to 4.6		V <sub>CC</sub> : OFF
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>I</sub> < 0
Output clamp current	I <sub>OK</sub>	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I <sub>O</sub>	±50	mA	$V_O = 0$ to $V_{CC}$
Continuous current through V <sub>CC</sub> or GND	I <sub>CC</sub> or I <sub>GND</sub>	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P <sub>T</sub>	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.



## **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>CC</sub>	1.2	3.6	V	
Input voltage range	Vı	0	3.6	V	
Output voltage range	Vo	0	Vcc	V	
Output current	I <sub>OH</sub>	_	-2	mA	V <sub>CC</sub> = 1.2 V
		_	-4		V <sub>CC</sub> = 1.4 V
		_	-6		V <sub>CC</sub> = 1.65 V
		_	-18		$V_{CC} = 2.3 \text{ V}$
		_	-24		$V_{CC} = 3.0 \text{ V}$
	I <sub>OL</sub>	_	2		V <sub>CC</sub> = 1.2 V
		_	4		V <sub>CC</sub> = 1.4 V
		_	6		V <sub>CC</sub> = 1.65 V
		_	18		$V_{CC} = 2.3 \text{ V}$
		_	24		$V_{CC} = 3.0 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

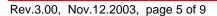
Note: Unused or floating inputs must be held high or low.

#### **Electrical Characteristics**

 $(Ta = -40 \text{ to } 85^{\circ}C)$ 

Item	Symbol	$V_{CC}(V)^*$	Min	Тур	Max	Unit	Test conditions
Threshold voltage	$V_T^+$	1.2	_	_	V <sub>CC</sub> ×0.8	V	
		1.4 to 1.6	_	_	V <sub>CC</sub> ×0.75	_	
		1.65 to 1.95	_	_	V <sub>CC</sub> ×0.7	=	
		2.3 to 2.7		_	1.7	=	
		3.0 to 3.6		_	2.0	=	
	$V_T^-$	1.2	V <sub>CC</sub> ×0.2	_	_		
		1.4 to 1.6	V <sub>CC</sub> ×0.25	_	_	=	
		1.65 to 1.95	V <sub>CC</sub> ×0.3	_	_	=	
		2.3 to 2.7	0.7	_	_	=	
		3.0 to 3.6	0.8	_	_	-	
	$\Delta V_T$	1.2	0.1	_	0.4		
		1.4 to 1.6	0.1	_	0.6	-	
		1.65 to 1.95	0.15	_	0.8	=	
		2.3 to 2.7	0.25	_	1.0	=	
		3.0 to 3.6	0.25	_	1.2	=	
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>CC</sub> -0.2	_	_	V	I <sub>OH</sub> = -100 μA
		1.2	0.9	_	_	_	$I_{OH} = -2 \text{ mA}$
		1.4	1.1	_	_	-	$I_{OH} = -4 \text{ mA}$
		1.65	1.2	_	_	=	$I_{OH} = -6 \text{ mA}$
		2.3	1.7	_	_	-	$I_{OH} = -18 \text{ mA}$
		3.0	2.2	_	_	-	$I_{OH} = -24 \text{ mA}$
	V <sub>OL</sub>	Min to Max	_	_	0.2	=	I <sub>OL</sub> = 100 μA
		1.2	_	_	0.3	-	I <sub>OL</sub> = 2 mA
		1.4	_	_	0.3	-	I <sub>OL</sub> = 4 mA
		1.65	_	_	0.3	_	I <sub>OL</sub> = 6 mA
		2.3	_	_	0.55	-	I <sub>OL</sub> = 18 mA
		3.0	_	_	0.55	-	I <sub>OL</sub> = 24 mA
Input current	I <sub>IN</sub>	3.6	_	_	±5	μΑ	V <sub>IN</sub> = 3.6 V or GND
Quiescent supply current	I <sub>CC</sub>	3.6	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	l <sub>OFF</sub>	0	_	_	5	μΑ	$V_{IN}$ or $V_{OUT} = 0$ to 3.6 V
Input capacitance	C <sub>IN</sub>	3.3		4.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.





## **Switching Characteristics**

 $(Ta = -40 \text{ to } 85^{\circ}C)$ 

 $V_{CC} = 1.2 \text{ V}$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	_	7.0	_	ns	$C_L = 15 pF$	А	Ÿ

 $V_{CC} = 1.5 \pm 0.1 \text{ V}$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	2.0	_	8.0	ns	$C_L = 15 pF$	A	Ÿ

 $V_{CC} = 1.8 \pm 0.15 \text{ V}$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	1.5	_	6.0	ns	$C_L = 30 pF$	Α	Ÿ

 $V_{CC} = 2.5 \pm 0.2 \text{ V}$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	1.0	_	4.5	ns	$C_L = 30 pF$	Α	Y

 $V_{CC} = 3.3 \pm 0.3 \text{ V}$ 

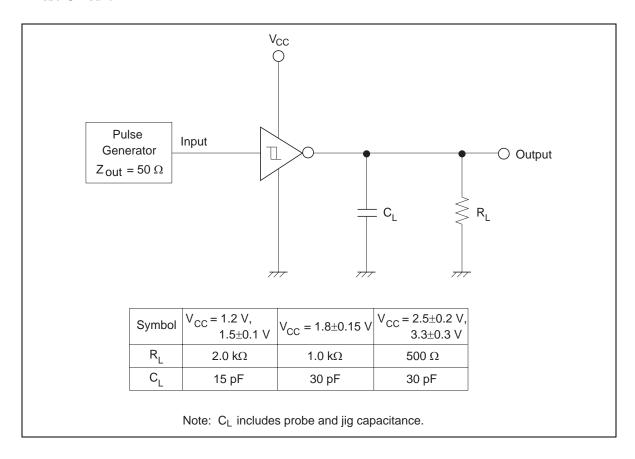
Item	Symbol	Min	Тур	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	1.0	_	3.5	ns	$C_L = 30 pF$	Α	Ÿ

# **Operating Characteristics**

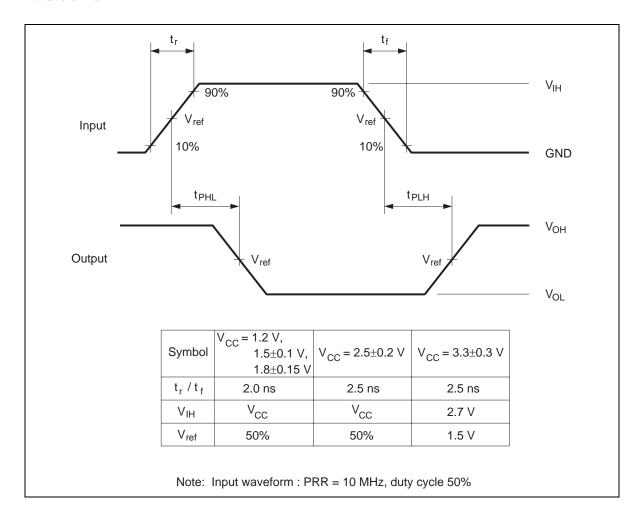
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	V <sub>CC</sub> (V)	Min	Тур	Max	Unit	Test conditions
Power dissipation	$C_{PD}$	1.5	_	10.5	_	pF	f = 10 MHz
capacitance		1.8	_	10.5	_		
		2.5	_	11.0	_	_	
		3.3	_	11.5	_		

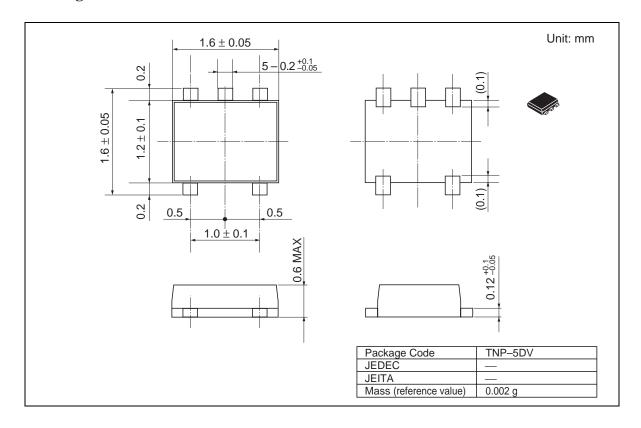
#### **Test Circuit**



#### Waveforms



## **Package Dimensions**



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